# 100V P-CHANNEL ENHANCEMENT MODE MOSFET

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## Product Summary

| $V_{(BR)DSS}$ | $R_{DS(on)}$ | $I_D$ $T_A$ = 25°C |
|---|---|---|
| -100V | 350mΩ @ $V_{GS}$= -10V | -3.9A |
| | 450mΩ @ $V_{GS}$= -6.0V | -3.4A |

## Features and Benefits

- Fast switching speed
- Low gate drive
- Low input capacitance
- **Qualified to AEC-Q101 Standards for High Reliability**

## Description and Applications

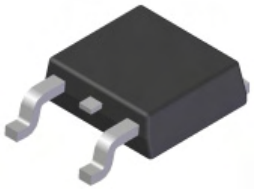
This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor control
- DC-DC Converters
- Power management functions
- Uninterrupted power supply

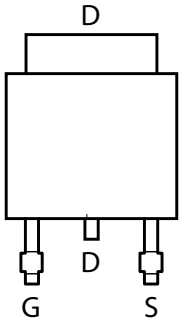
## Mechanical Data

- Case: TO252-3L
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.33 grams (approximate)

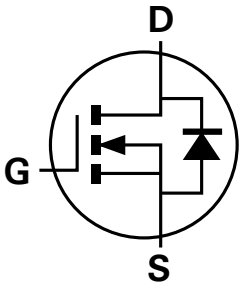
TO252-3L



Top View




Pin Out – Top View

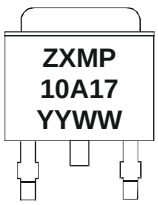



Equivalent Circuit

## Ordering Information

| Product | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|---|---|---|---|---|
| ZXMP10A17KTC | See below | 13 | 16 | 2,500 |

## Marking Information




ZXMP = Product Type Marking Code, Line 1
10A17 = Product Type Marking Code, Line 2
YYWW = Date Code Marking
YY = Year (ex: 09 = 2009)
WW = Week (01-52)

## Maximum Ratings @$T_A$ = 25°C unless otherwise specified

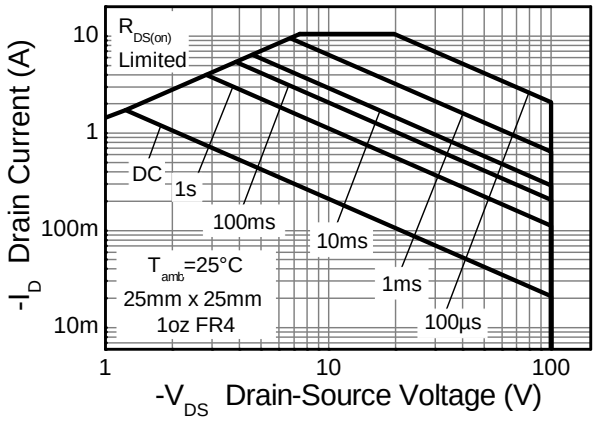
| Characteristic | | | Symbol | Value | Unit |
|---|---|---|---|---|---|
| Drain-Source voltage | | | $V_{DSS}$ | -100 | V |
| Gate-Source voltage | | | $V_{GS}$ | ±20 | V |
| Continuous Drain current | $V_{GS}$ = 10V | (Note 2) | $I_D$ | -3.9 | A |
| | | $T_A$ = 70°C (Note 2) | | -3.1 | |
| | | (Note 1) | | -2.4 | |
| Pulsed Drain current | $V_{GS}$= 10V | (Note 3) | $I_{DM}$ | -11.3 | A |
| Continuous Source current (Body diode) | | (Note 2) | $I_S$ | -8.7 | A |
| Pulsed Source current (Body diode) | | (Note3 ) | $I_{SM}$ | -11.3 | A |

## Thermal Characteristics @$T_A$ = 25°C unless otherwise specified

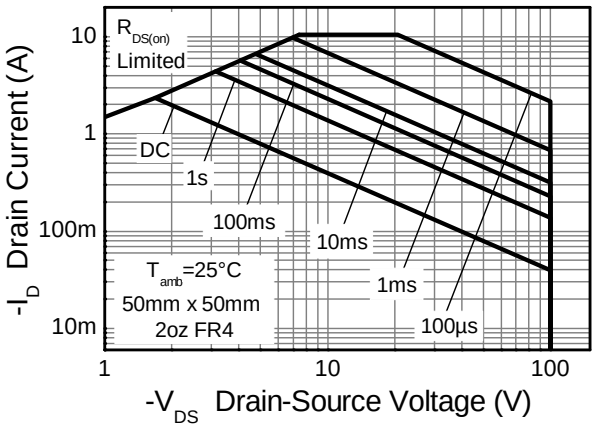
| Characteristic | | Symbol | Value | Unit |
|---|---|---|---|---|
| Power dissipation<br>Linear derating factor | (Note 1) | $P_D$ | 4.0<br>32.0 | W<br>mW/°C |
| | (Note 2) | | 10.2<br>80.8 | |
| | (Note 5) | | 2.0<br>16.1 | |
| Thermal Resistance, Junction to Ambient | (Note 1) | $R_{\theta JA}$ | 31 | °C/W |
| | (Note 2) | | 12.3 | |
| | (Note 5) | | 62 | |
| Thermal Resistance, Junction to Case | (Note 4) | $R_{\theta JL}$ | 2.4 | °C/W |
| Operating and storage temperature range | | $T_J$, $T_{STG}$ | -55 to 150 | °C |

Notes:
1. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
2. Same as note (1), except the device is measured at t ≤ 10 sec.
3. Same as note (1), except the device is pulsed with D= 0.02 and pulse width 300 µs. The pulse current is limited by the maximum junction temperature.
4. Thermal resistance from junction to solder-point (at the end of the drain lead).
5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

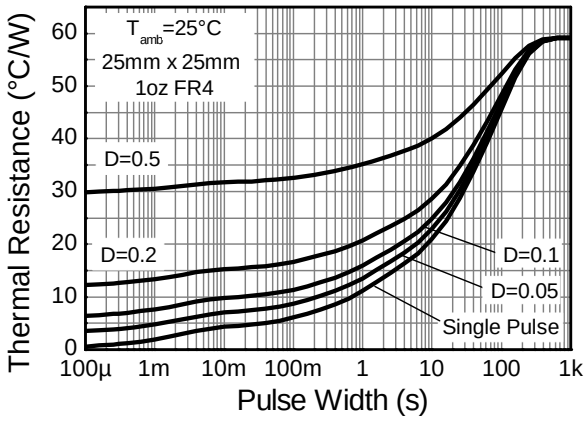
## Thermal Characteristics



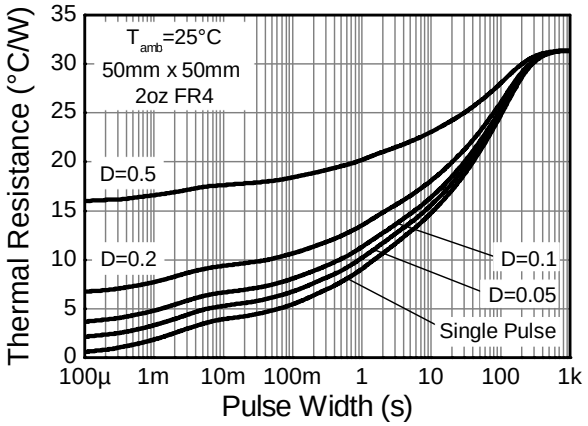

**Safe Operating Area**



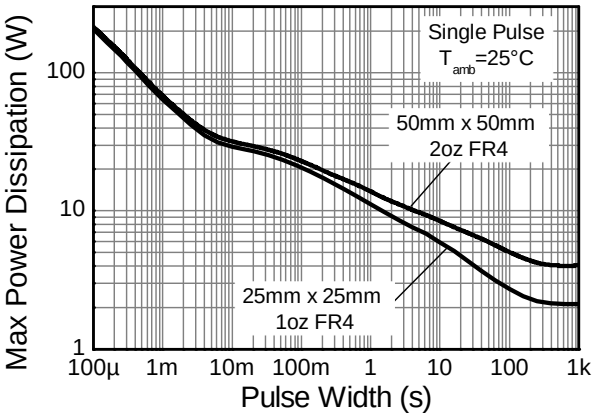

**Safe Operating Area**



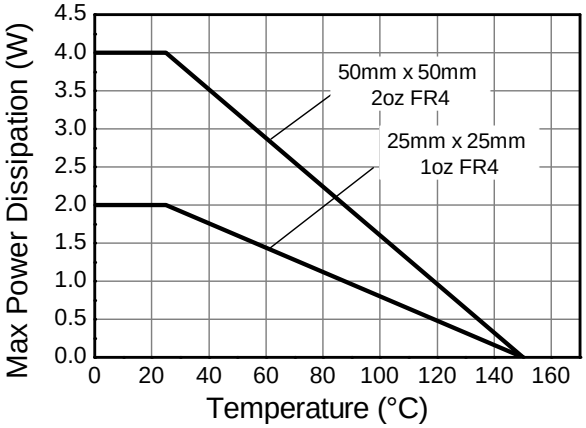

**Transient Thermal Impedance**




**Transient Thermal Impedance**




**Pulse Power Dissipation**



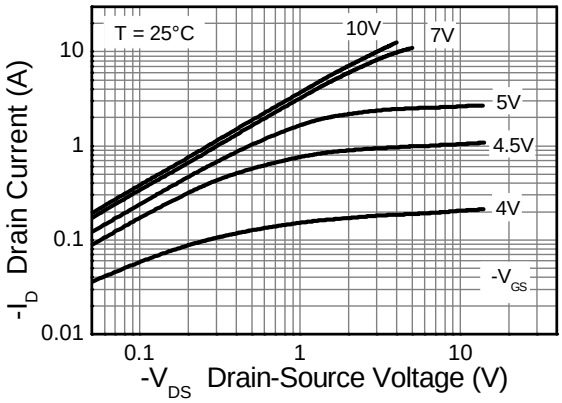

**Derating Curve**

## Electrical Characteristics @$T_A$ = 25°C unless otherwise specified

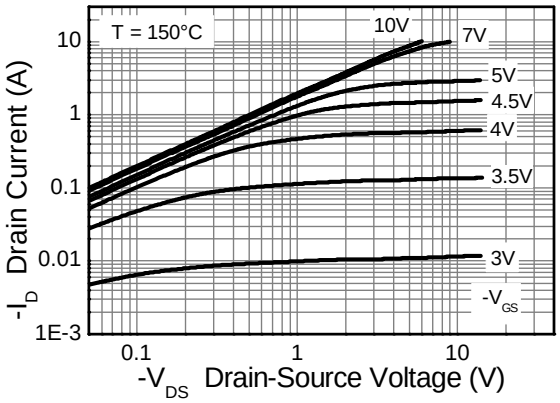
| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|---|---|---|---|---|---|---|
| **OFF CHARACTERISTICS** | | | | | | |
| Drain-Source Breakdown Voltage | $BV_{DSS}$ | -100 | — | — | V | $I_D$ = -250μA, $V_{GS}$= 0V |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | — | — | -0.5 | μA | $V_{DS}$= -100V, $V_{GS}$= 0V |
| Gate-Source Leakage | $I_{GSS}$ | — | — | ±100 | nA | $V_{GS}$= ±20V, $V_{DS}$= 0V |
| **ON CHARACTERISTICS** | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | -2.0 | — | -4.0 | V | $I_D$= -250μA, $V_{DS}$= $V_{GS}$ |
| Static Drain-Source On-Resistance (Note 6) | $R_{DS\ (ON)}$ | — | — | 0.350 | Ω | $V_{GS}$= -10V, $I_D$= -1.4A |
| | | | | 0.450 | | $V_{GS}$= -6V, $I_D$= -1.2A |
| Forward Transconductance (Notes 6 & 7) | $g_{fs}$ | — | 2.8 | — | S | $V_{DS}$= -15V, $I_D$= -1.4A |
| Diode Forward Voltage (Note 6) | $V_{SD}$ | — | -0.85 | -0.95 | V | $I_S$= -1.7A, $V_{GS}$= 0V |
| Reverse recovery time (Note 7) | $t_{rr}$ | | 33 | — | ns | $I_S$= -1.5A, di/dt= 100A/μs |
| Reverse recovery charge (Note 7) | $Q_{rr}$ | — | 48 | — | nC | |
| **DYNAMIC CHARACTERISTICS** (Note 7) | | | | | | |
| Input Capacitance | $C_{iss}$ | — | 424 | — | pF | $V_{DS}$= -50V, $V_{GS}$= 0V<br>f= 1MHz |
| Output Capacitance | $C_{oss}$ | — | 36.6 | — | pF | |
| Reverse Transfer Capacitance | $C_{rss}$ | — | 29.8 | — | pF | |
| Total Gate Charge (Note 8) | $Q_g$ | — | 7.1 | — | nC | $V_{GS}$= -6.0V<br>$V_{DS}$= -50V<br>$I_D$= -1.4A |
| Total Gate Charge (Note 8) | $Q_g$ | — | 10.7 | — | nC | $V_{GS}$= -10V |
| Gate-Source Charge (Note 8) | $Q_{gs}$ | — | 1.7 | — | nC | |
| Gate-Drain Charge (Note 8) | $Q_{gd}$ | — | 3.8 | — | nC | |
| Turn-On Delay Time (Note 8) | $t_{D(on)}$ | — | 3.0 | — | ns | $V_{DD}$= -50V, $V_{GS}$= -10V<br>$I_D$= -1A, $R_G \cong 6.0\Omega$ |
| Turn-On Rise Time (Note 8) | $t_r$ | — | 3.5 | — | ns | |
| Turn-Off Delay Time (Note 8) | $t_{D(off)}$ | — | 13.4 | — | ns | |
| Turn-Off Fall Time (Note 8) | $t_f$ | — | 7.2 | — | ns | |

Notes:
6. Measured under pulsed conditions. Pulse width ≤ 300μs; duty cycle ≤ 2%
7. For design aid only, not subject to production testing.
8. Switching characteristics are independent of operating junction temperatures.

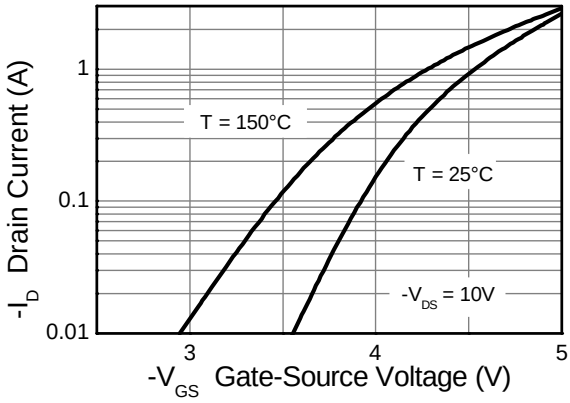
## Typical Characteristics



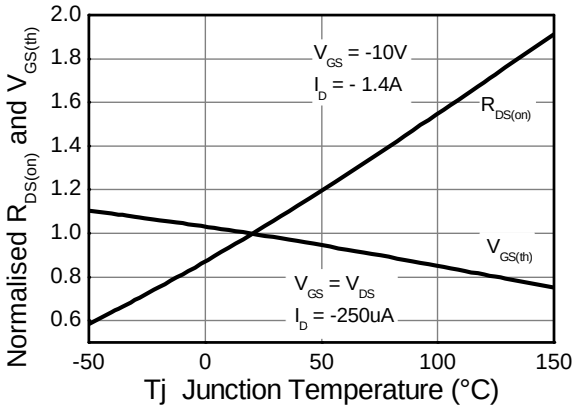

**Output Characteristics**



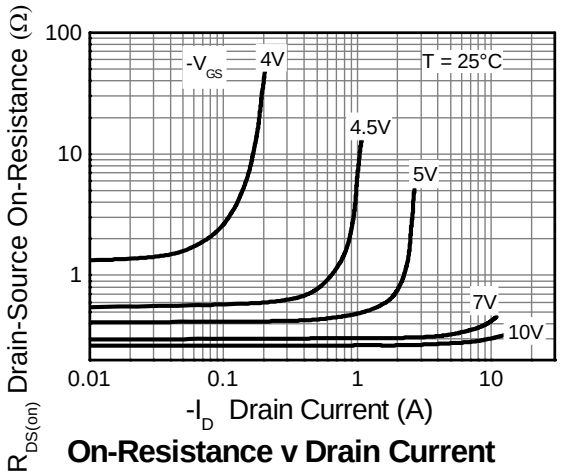

**Output Characteristics**



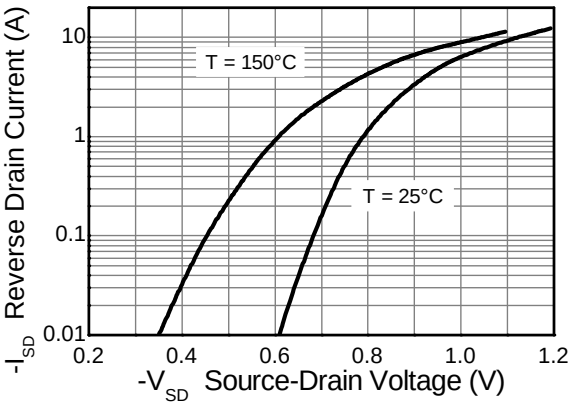

**Typical Transfer Characteristics**




**Normalised Curves v Temperature**

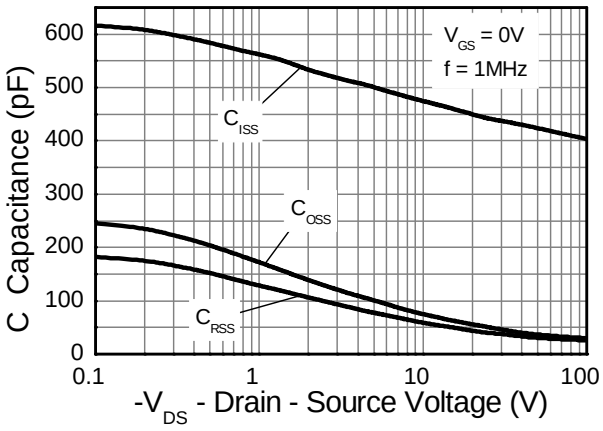



**On-Resistance v Drain Current**

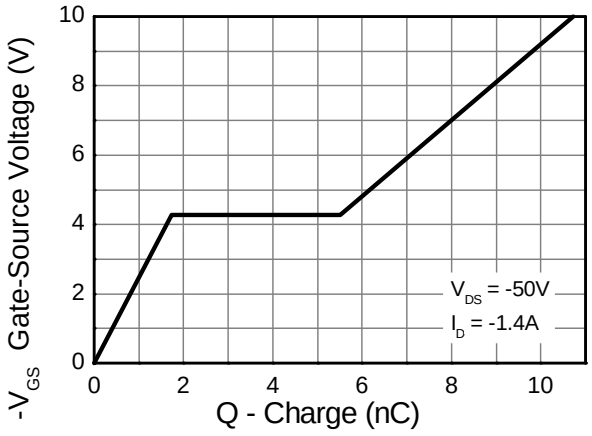



**Source-Drain Diode Forward Voltage**

## Typical Characteristics - continued

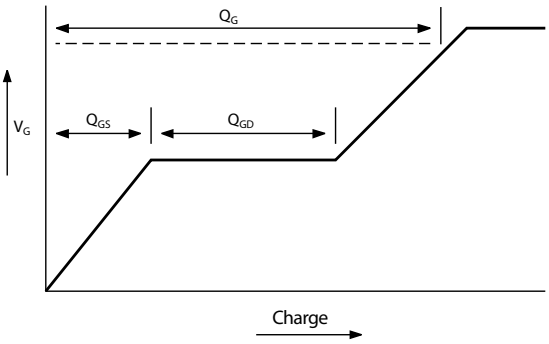



**Capacitance v Drain-Source Voltage**

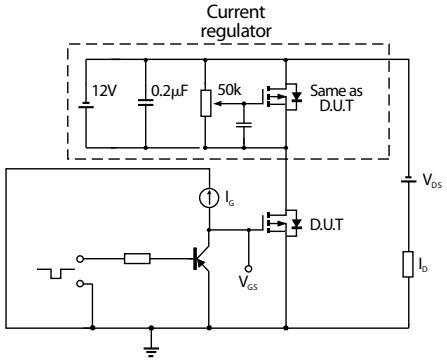



**Gate-Source Voltage v Gate Charge**

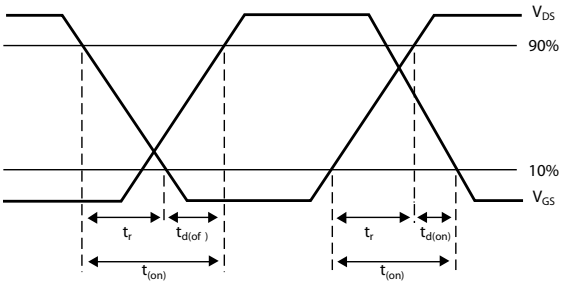
## Test Circuits



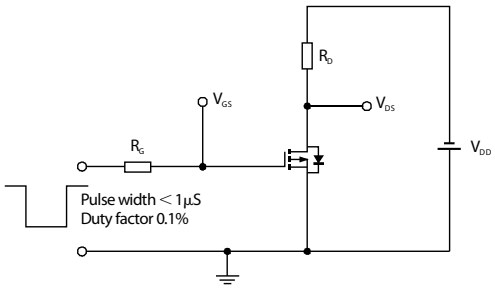

**Basic gate charge waveform**




**Gate charge test circuit**

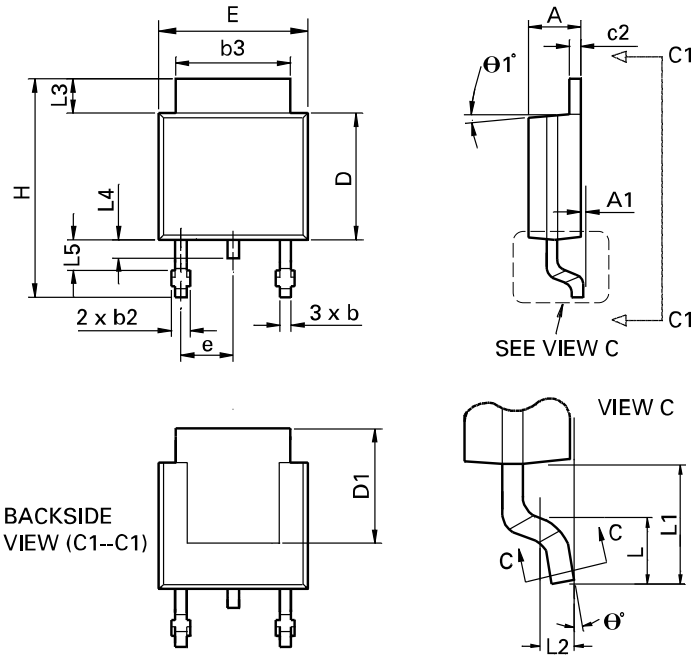



**Switching time waveforms**



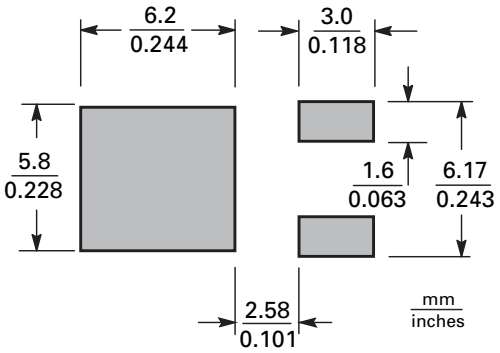

**Switching time test circuit**

## Package Outline Dimensions




| DIM | Inches | | Millimeters | | DIM | Inches | | Millimeters | |
|---|---|---|---|---|---|---|---|---|---|
| | Min | Max | Min | Max | | Min | Max | Min | Max |
| **A** | 0.086 | 0.094 | 2.18 | 2.39 | **e** | 0.090 BSC | | 2.29 BSC | |
| **A1** | - | 0.005 | - | 0.127 | **H** | 0.370 | 0.410 | 9.40 | 10.41 |
| **b** | 0.020 | 0.035 | 0.508 | 0.89 | **L** | 0.055 | 0.070 | 1.40 | 1.78 |
| **b2** | 0.030 | 0.045 | 0.762 | 1.14 | **L1** | 0.108 REF | | 2.74 REF | |
| **b3** | 0.205 | 0.215 | 5.21 | 5.46 | **L2** | 0.020 BSC | | 0.508 BSC | |
| **c** | 0.018 | 0.024 | 0.457 | 0.61 | **L3** | 0.035 | 0.065 | 0.89 | 1.65 |
| **c2** | 0.018 | 0.023 | 0.457 | 0.584 | **L4** | 0.025 | 0.040 | 0.635 | 1.016 |
| **D** | 0.213 | 0.245 | 5.41 | 6.22 | **L5** | 0.045 | 0.060 | 1.14 | 1.52 |
| **D1** | 0.205 | - | 5.21 | - | **θ1°** | 0° | 10° | 0° | 10° |
| **E** | 0.250 | 0.265 | 6.35 | 6.73 | **θ°** | 0° | 15° | 0° | 15° |
| **E1** | 0.170 | - | 4.32 | - | - | - | - | - | - |

## Suggested Pad Layout



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- Техническая поддержка проекта;
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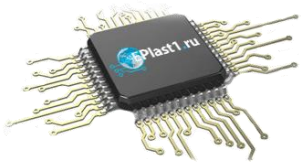


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